



YEA SHIN TECHNOLOGY CO., LTD

YS2314S

N-Channel Enhancement MOSFET

VDS= 20V, ID= 5.8A



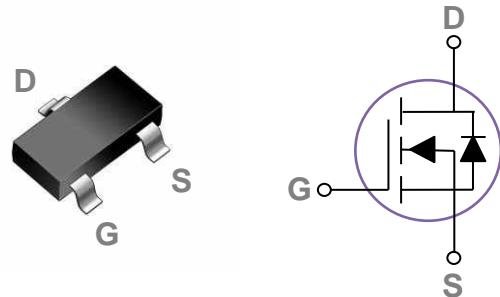
Features

- 20V, 5.8A, $R_{DS(ON)} = 25m\Omega$ @ $V_{GS} = 4.5V$
- Improved dv/dt capability
- Fast switching
- Green Device Available
- Suit for 1.8V Gate Drive Applications

Applications

- Notebook
- Load Switch
- Hand-Held Instruments

SOT-23 Pin Configuration



Absolute Maximum Rating $T_c=25^\circ C$ unless otherwise noted

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	20	V
V_{GS}	Gate-Source Voltage	± 10	V
I_D	Drain Current – Continuous ($T_c=25^\circ C$)	5.8	A
	Drain Current – Continuous ($T_c=100^\circ C$)	3.7	A
I_{DM}	Drain Current – Pulsed ¹	23.2	A
P_D	Power Dissipation ($T_c=25^\circ C$)	1.56	W
	Power Dissipation – Derate above 25°C	0.012	W/°C
T_{STG}	Storage Temperature Range	-55 to 150	°C
T_J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient	---	80	°C /W

DEVICE CHARACTERISTICS

YS2314S

Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=250\mu\text{A}$	20	---	---	V
$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	BV_{DSS} Temperature Coefficient	Reference to 25°C , $\text{I}_D=1\text{mA}$	---	0.02	---	$\text{V}/^\circ\text{C}$
I_{DSS}	Drain-Source Leakage Current	$\text{V}_{\text{DS}}=20\text{V}, \text{V}_{\text{GS}}=0\text{V}, T_J=25^\circ\text{C}$	---	---	1	μA
		$\text{V}_{\text{DS}}=16\text{V}, \text{V}_{\text{GS}}=0\text{V}, T_J=85^\circ\text{C}$	---	---	10	μA
I_{GSS}	Gate-Source Leakage Current	$\text{V}_{\text{GS}}=\pm 10\text{V}, \text{V}_{\text{DS}}=0\text{V}$	---	---	± 100	nA

On Characteristics

$\text{R}_{\text{DS(ON)}}$	Static Drain-source On-Resistance	$\text{V}_{\text{GS}}=4.5\text{V}, \text{I}_D=4\text{A}$	---	20	25	$\text{m}\Omega$
		$\text{V}_{\text{GS}}=2.5\text{V}, \text{I}_D=3\text{A}$	---	27	35	$\text{m}\Omega$
		$\text{V}_{\text{GS}}=1.8\text{V}, \text{I}_D=2\text{A}$	---	39	55	$\text{m}\Omega$
$\text{V}_{\text{GS(th)}}$	Gate Threshold Voltage	$\text{V}_{\text{GS}}=\text{V}_{\text{DS}}, \text{I}_D=250\mu\text{A}$	0.4	0.6	0.8	V
$\Delta \text{V}_{\text{GS(th)}}$	$\text{V}_{\text{GS(th)}}$ Temperature Coefficient		---	-2	---	$\text{mV}/^\circ\text{C}$
g_{fs}	Forward Transconductance	$\text{V}_{\text{DS}}=10\text{V}, \text{I}_D=3\text{A}$	---	6.5	---	S

Dynamic and Switching Characteristics

Q_g	Total Gate Charge ^{2,3}	$\text{V}_{\text{DS}}=10\text{V}, \text{V}_{\text{GS}}=4.5\text{V}, \text{I}_D=4\text{A}$	---	7.7	11	nC
Q_{gs}	Gate-Source Charge ^{2,3}		---	0.9	1	
Q_{gd}	Gate-Drain Charge ^{2,3}		---	2.4	5	
$\text{T}_{\text{d(on)}}$	Turn-On Delay Time ^{2,3}	$\text{V}_{\text{DD}}=10\text{V}, \text{V}_{\text{GS}}=4.5\text{V}, \text{R}_G=25\Omega, \text{I}_D=1\text{A}$	---	4.1	8	ns
T_r	Rise Time ^{2,3}		---	11.6	22	
$\text{T}_{\text{d(off)}}$	Turn-On Delay Time ^{2,3}		---	23.9	45	
T_f	Fall Time ^{2,3}		---	7.6	14	
C_{iss}	Input Capacitance	$\text{V}_{\text{DS}}=10\text{V}, \text{V}_{\text{GS}}=0\text{V}, f=1\text{MHz}$	---	535	775	pF
C_{oss}	Output Capacitance		---	60	85	
C_{rss}	Reverse Transfer Capacitance		---	34	50	

Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_s	Continuous Source Current	$\text{V}_G=\text{V}_D=0\text{V}$, Force Current	---	---	5.8	A
I_{SM}	Pulsed Source Current		---	---	23.2	A
V_{SD}	Diode Forward Voltage	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_s=1\text{A}, T_J=25^\circ\text{C}$	---	---	1	V

Note :

- Repetitive Rating : Pulsed width limited by maximum junction temperature.
- The data tested by pulsed , pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.
- Essentially independent of operating temperature.

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YS2314S

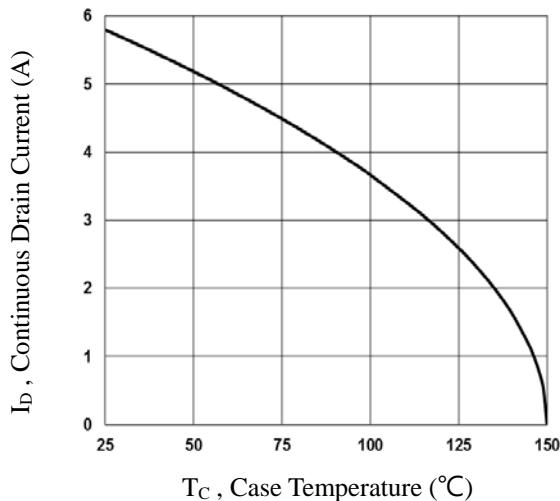


Fig.1 Continuous Drain Current vs. T_c

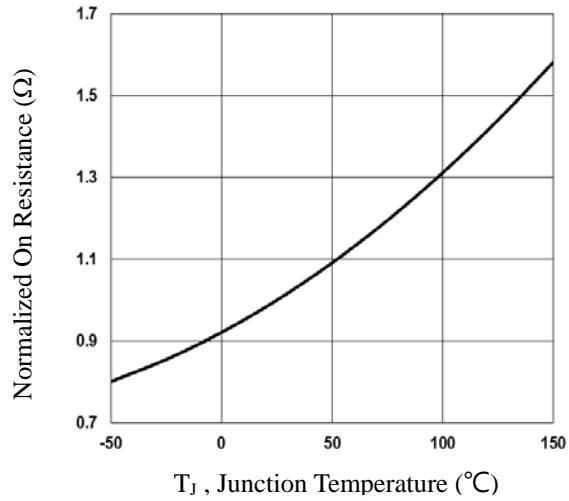


Fig.2 Normalized RDS(on) vs. T_j

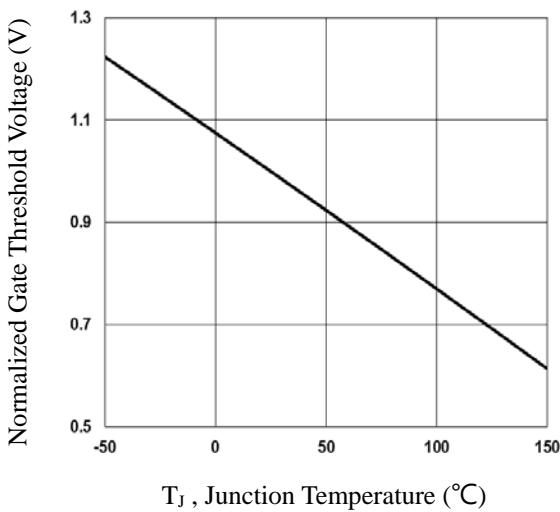


Fig.3 Normalized V_{th} vs. T_j

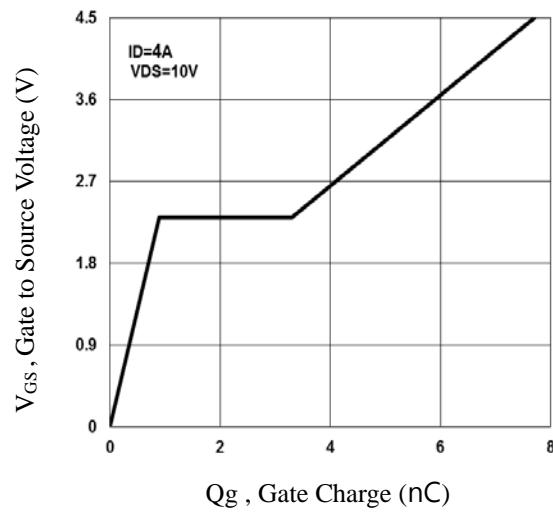


Fig.4 Gate Charge Waveform

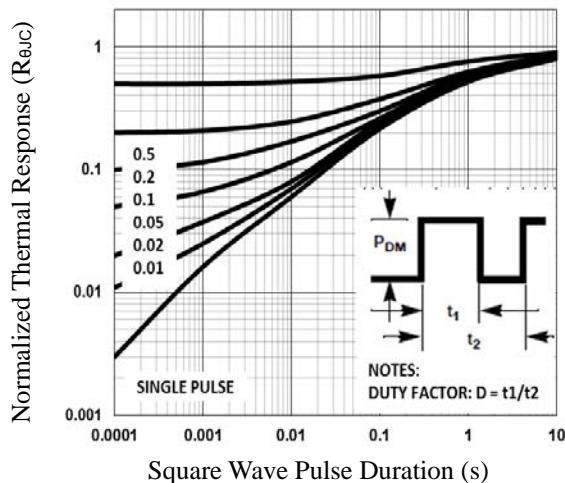


Fig.5 Normalized Transient Impedance

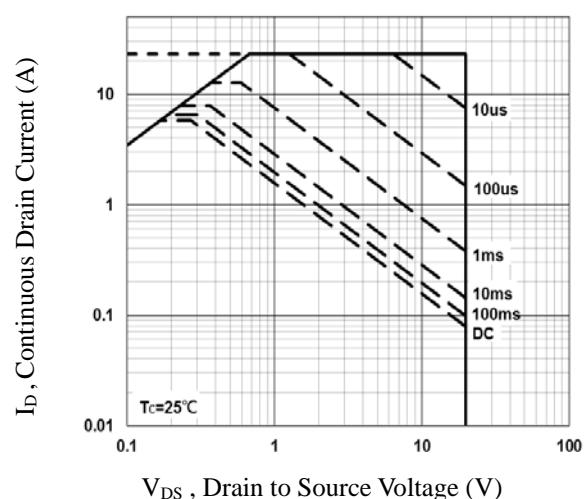


Fig.6 Maximum Safe Operation Area

DEVICE CHARACTERISTICS

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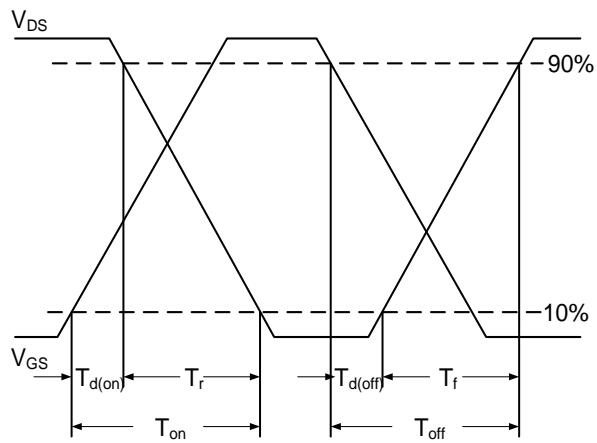


Fig.7 Switching Time Waveform

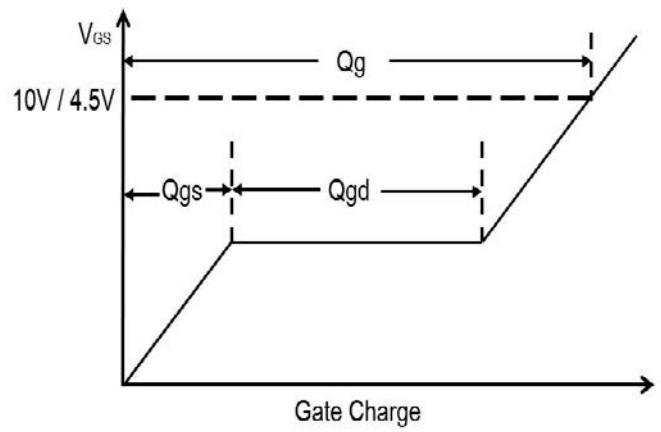
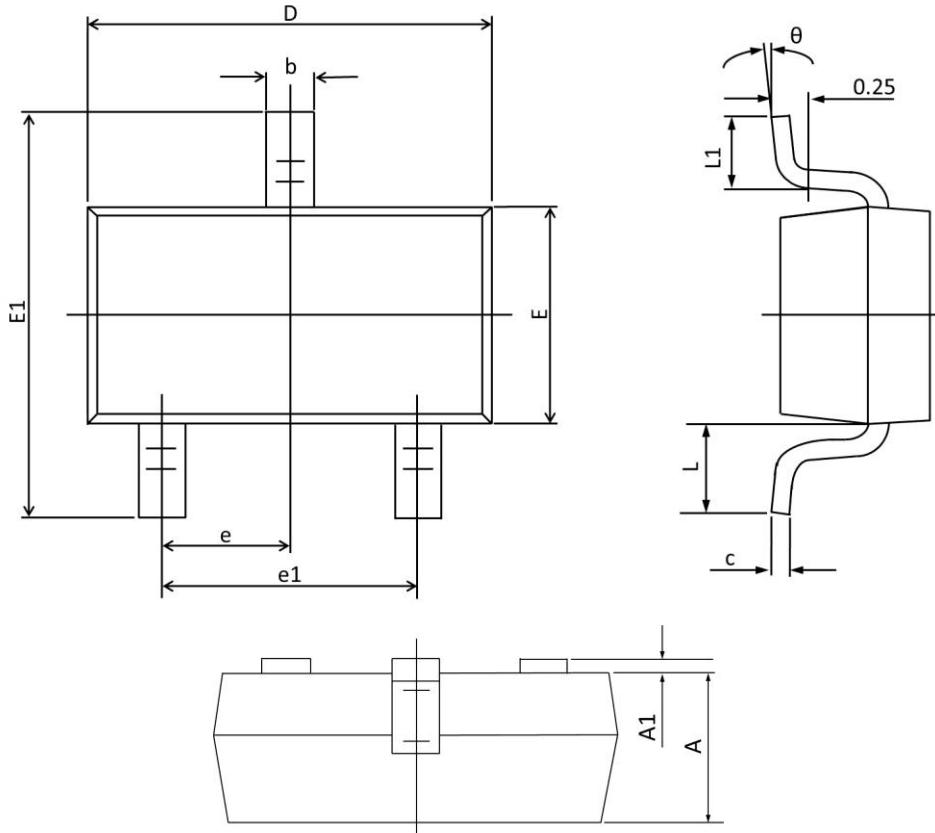


Fig.8 Gate Charge Waveform

PACKAGE OUTLINE & DIMENSIONS

YS2314S



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.000	0.035	0.039
A1	0.000	0.100	0.000	0.004
b	0.300	0.500	0.012	0.020
c	0.090	0.110	0.003	0.004
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP.		0.037 TYP.	
e1	1.800	2.000	0.071	0.079
L	0.550 REF.		0.022 REF.	
L1	0.300	0.500	0.012	0.020
θ	1°	7°	1°	7°